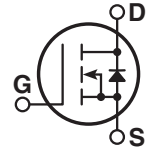
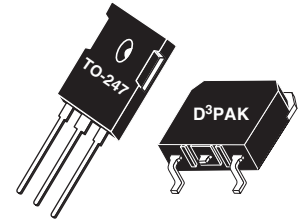




Super Junction MOSFET

- Ultra Low $R_{DS(on)}$
- Low Miller Capacitance
- Ultra Low Gate Charge, Q_g
- Avalanche Energy Rated
- Extreme dv/dt Rated



MAXIMUM RATINGS

All Ratings per die: $T_C = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	APT30N60B_SC6	UNIT
V_{DSS}	Drain-Source Voltage	600	Volts
I_D	Continuous Drain Current @ $T_C = 25^\circ\text{C}$	30	Amps
	Continuous Drain Current @ $T_C = 100^\circ\text{C}$	19	
I_{DM}	Pulsed Drain Current ¹	89	
V_{GS}	Total Power Dissipation @ $T_C = 25^\circ\text{C}$	± 20	Volts
P_D	Gate-Source Voltage Continuous	219	Watts
T_J, T_{STG}	Operating and Storage Junction Temperature Range	- 55 to 150	$^\circ\text{C}$
T_L	Lead Temperature: 0.063" from Case for 10 Sec.	260	
dv/dt	Drain-Source Voltage slope ($V_{DS} = 480\text{V}$, $I_D = 30\text{A}$, $T_J = 125^\circ\text{C}$)	15	V/ns
I_{AR}	Avalanche Current ²	5.2	Amps
E_{AR}	Repetitive Avalanche Energy ² ($I_d = 5.2\text{A}$, $V_{dd} = 50\text{V}$)	0.96	mJ
E_{AS}	Single Pulse Avalanche Energy ($I_d = 5.2\text{A}$, $V_{dd} = 50\text{V}$)	636	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$BV_{(DSS)}$	Drain-Source Breakdown Voltage ($V_{GS} = 0\text{V}$, $I_D = 250\mu\text{A}$)	600			Volts
$R_{DS(on)}$	Drain-Source On-State Resistance ³ ($V_{GS} = 10\text{V}$, $I_D = 14.5\text{A}$)		0.11	0.125	Ohms
I_{DSS}	Zero Gate Voltage Drain Current ($V_{DS} = 600\text{V}$, $V_{GS} = 0\text{V}$)			25	μA
	Zero Gate Voltage Drain Current ($V_{DS} = 600\text{V}$, $V_{GS} = 0\text{V}$, $T_C = 150^\circ\text{C}$)			100	
I_{GSS}	Gate-Source Leakage Current ($V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$)			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage ($V_{DS} = V_{GS}$, $I_D = 960\mu\text{A}$)	2.5	3	3.5	Volts

 CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

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Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{iss}	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1\text{ MHz}$		2267		pF
C_{oss}	Output Capacitance			1990		
C_{rss}	Reverse Transfer Capacitance			203		
Q_g	Total Gate Charge ⁴	$V_{GS} = 10V$ $V_{DD} = 300V$ $I_D = 30A @ 25^\circ C$		88		nC
Q_{gs}	Gate-Source Charge			12		
Q_{gd}	Gate-Drain ("Miller") Charge			46		
$t_{d(on)}$	Turn-on Delay Time	INDUCTIVE SWITCHING $V_{GS} = 15V$ $V_{DD} = 400V$ $I_D = 30A @ 25^\circ C$ $R_G = 4.3\Omega$		9		ns
t_r	Rise Time			17		
$t_{d(off)}$	Turn-off Delay Time			74		
t_f	Fall Time			48		
E_{on}	Turn-on Switching Energy ⁵	INDUCTIVE SWITCHING @ 25°C $V_{DD} = 400V, V_{GS} = 15V$ $I_D = 30A, R_G = 4.3\Omega$		409		μJ
E_{off}	Turn-off Switching Energy			224		
E_{on}	Turn-on Switching Energy ⁵	INDUCTIVE SWITCHING @ 125°C $V_{DD} = 400V, V_{GS} = 15V$ $I_D = 30A, R_G = 4.3\Omega$		649		
E_{off}	Turn-off Switching Energy			282		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I_S	Continuous Source Current (Body Diode)		26		Amps
I_{SM}	Pulsed Source Current ¹ (Body Diode)		65		Amps
V_{SD}	Diode Forward Voltage ³ ($V_{GS} = 0V, I_S = -30A$)			1.30	Volts
dv/dt	Peak Diode Recovery dv/dt ⁶		15		V/ns
t_{rr}	Reverse Recovery Time ($I_S = -30A, di/dt = 100A/\mu s$)	$T_J = 25^\circ C$	661		ns
		$T_J = 125^\circ C$	813		
Q_{rr}	Reverse Recovery Charge ($I_S = -30A, di/dt = 100A/\mu s$)	$T_J = 25^\circ C$	15		μC
		$T_J = 125^\circ C$	18		
I_{RRM}	Peak Recovery Current ($I_S = -30A, di/dt = 100A/\mu s$)	$T_J = 25^\circ C$	46		Amps
		$T_J = 125^\circ C$	48		

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			0.52	$^\circ C/W$
$R_{\theta JA}$	Junction to Ambient			31	

- 1 Repetitive Rating: Pulse width limited by maximum junction temperature
- 2 Repetitive avalanche causes additional power losses that can be calculated as $P_{AV} = E_{AR} \cdot f$. Pulse width tp limited by Tj max.
- 3 Pulse Test: Pulse width < 380 μs , Duty Cycle < 2%
- 4 See MIL-STD-750 Method 3471
- 5 Eon includes diode reverse recovery.
- 6 Maximum 125°C diode commutation speed = di/dt 600A/ μs

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

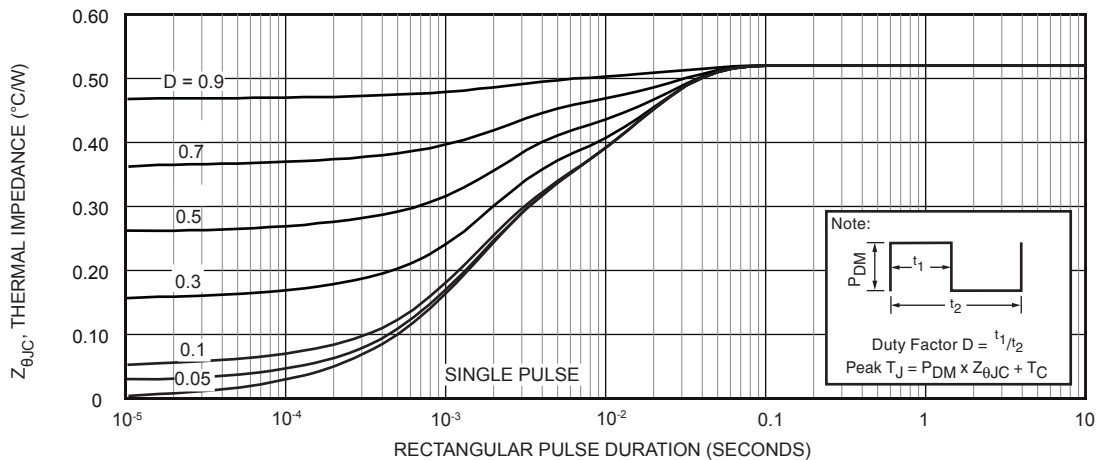


Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

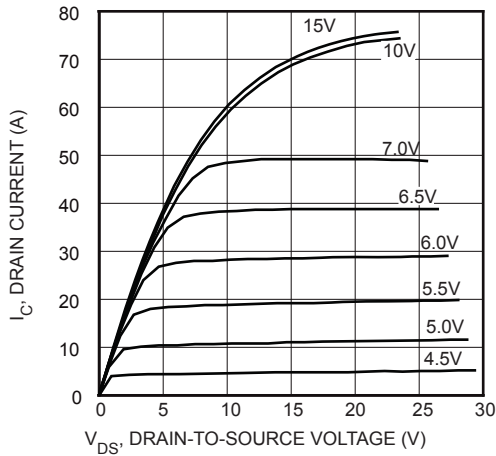


FIGURE 2, Low Voltage Output Characteristics

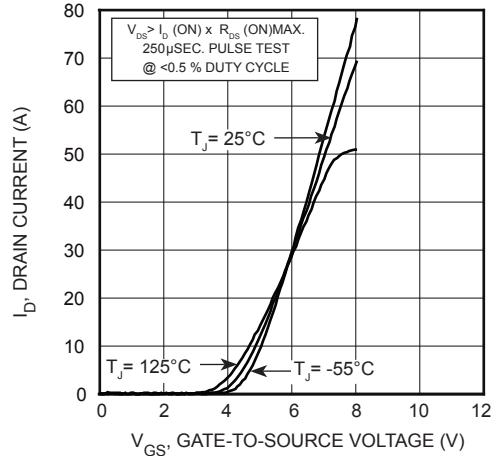


FIGURE 3, Transfer Characteristics

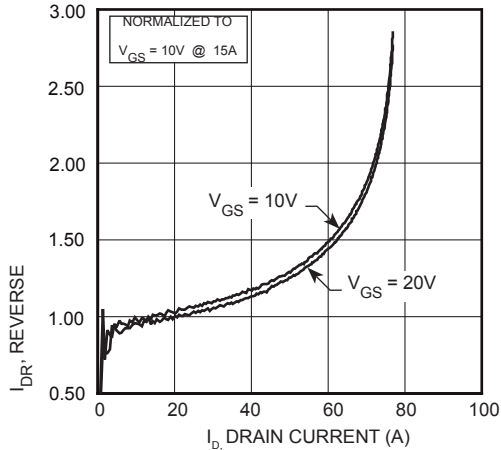


FIGURE 4, $R_{DS}(ON)$ vs Drain Current

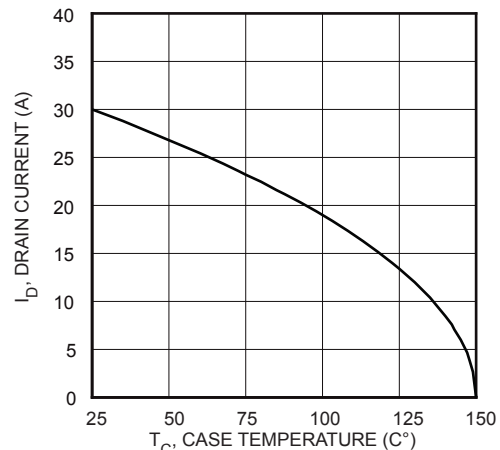


FIGURE 5, Maximum Drain Current vs Case Temperature

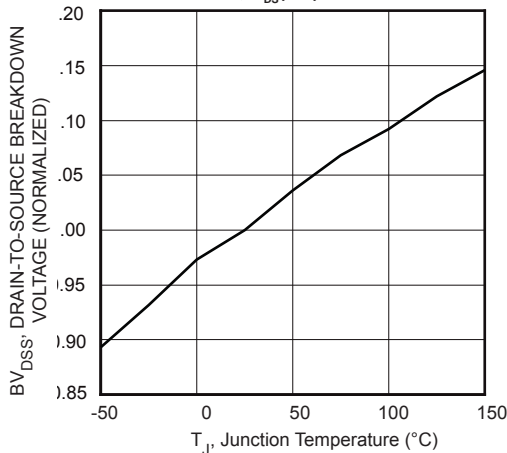


FIGURE 6, Breakdown Voltage vs Temperature

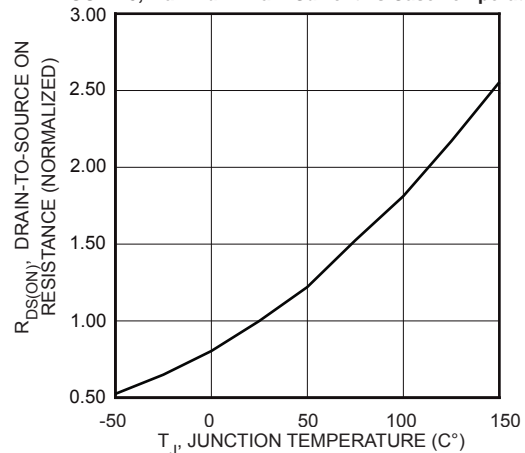


FIGURE 7, On-Resistance vs Temperature

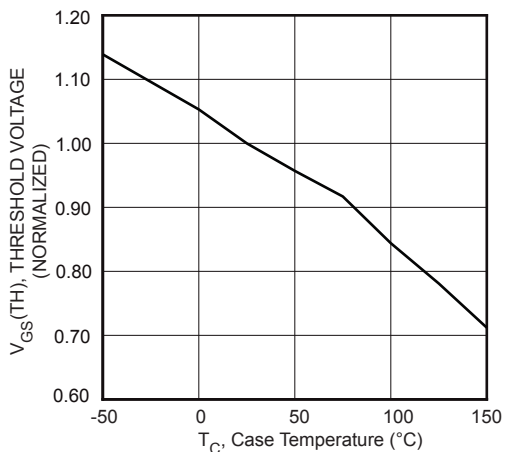


FIGURE 8, Threshold Voltage vs Temperature

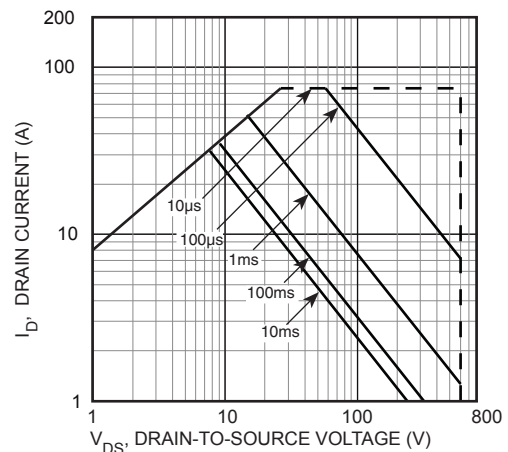


FIGURE 9, Maximum Safe Operating Area

Typical Performance Curves

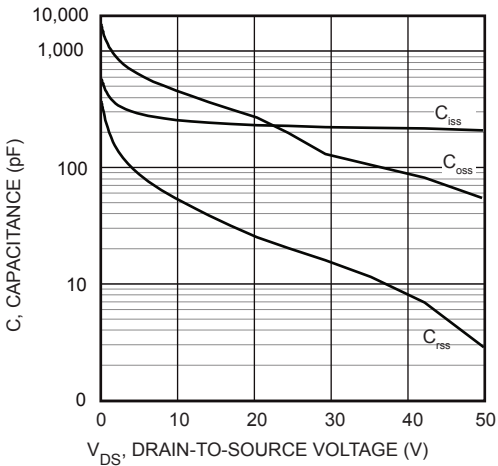


FIGURE 10, Capacitance vs Drain-To-Source Voltage

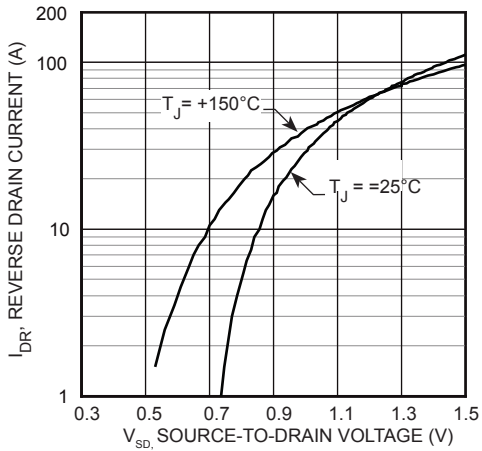


FIGURE 12, Source-Drain Diode Forward Voltage

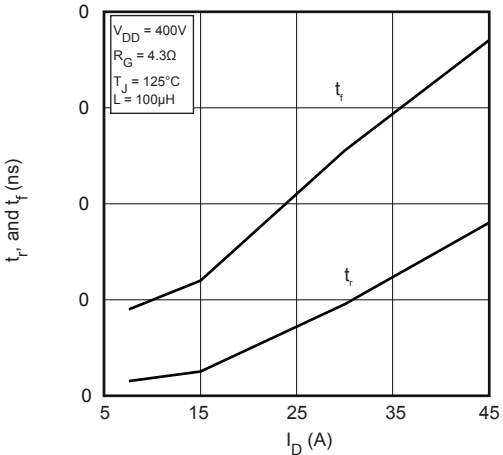


FIGURE 14, Rise and Fall Times vs Current

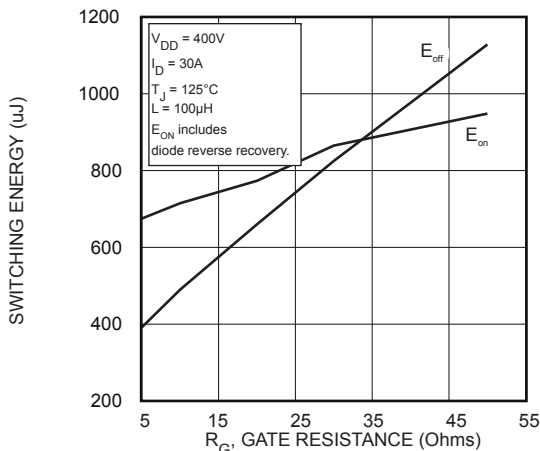


FIGURE 16, Switching Energy vs Gate Resistance

APT30N60B_SC6

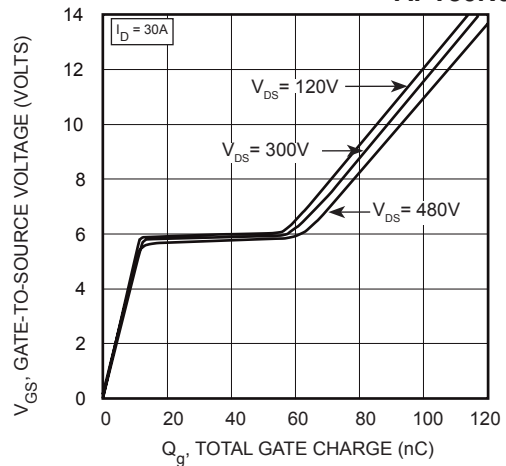


FIGURE 11, Gate Charges vs Gate-To-Source Voltage

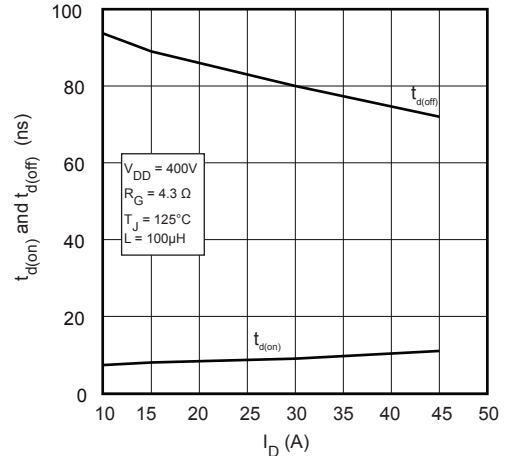


FIGURE 13, Delay Times vs Current

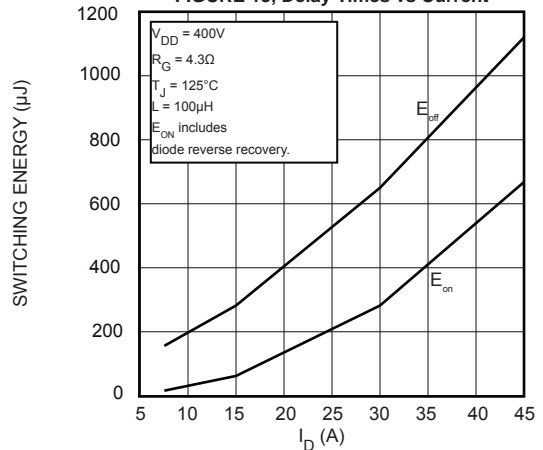


FIGURE 15, Switching Energy vs Current

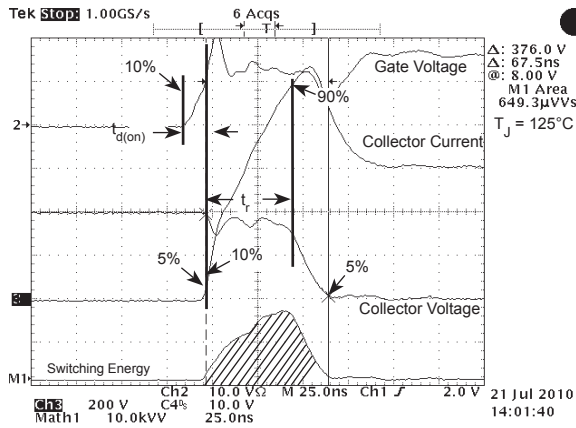


Figure 17, Turn-on Switching Waveforms and Definitions

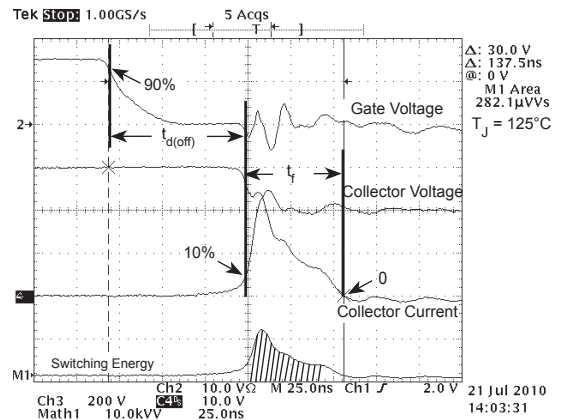


Figure 18, Turn-off Switching Waveforms and Definitions

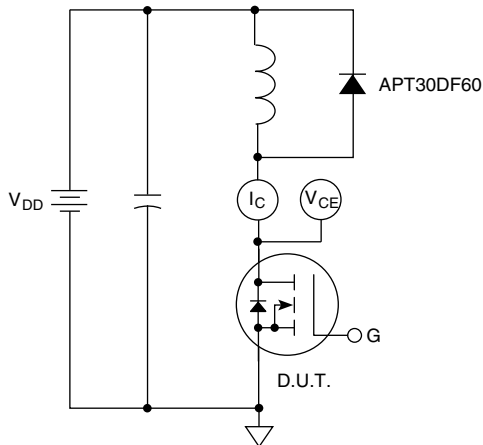
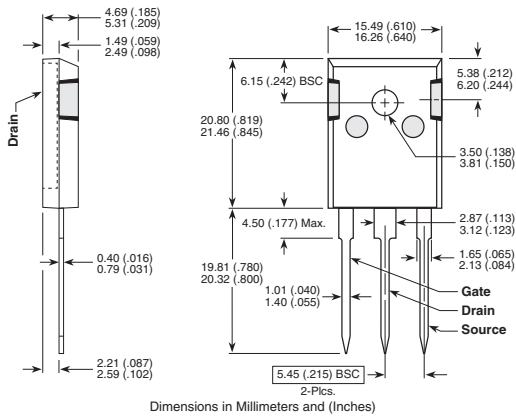


Figure 19, Inductive Switching Test Circuit

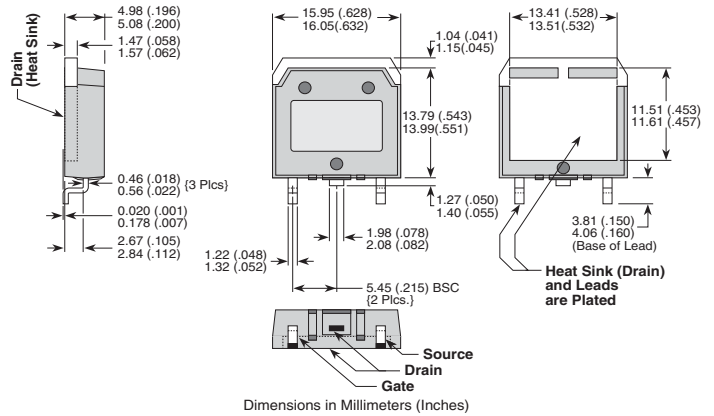
TO-247 Package Outline



Dimensions in Millimeters and (Inches)

D³PAK Package Outline

Ⓧ100% Sn



Dimensions in Millimeters (Inches)

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